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Polishing-induced contamination of fused silica optics and laser induced damage density at 351 nm

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Abstract: In this paper we study the effect of contamination induced by fabrication process on laser damage density of fused silica polished parts at 351 nm in nanosecond regime. We show, owing to recent developments of our raster scan metrology, that a good correlation exists between damage density and concentration of certain contaminants for the considered parts.

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OCIS codes: (220.5450) Polishing; (140.3330) Laser damage; (160.2750) Glass and other amorphous materials

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1. Introduction

Lifetime in the UV of fused silica optics used in large high power laser facilities such as Megajoule laser (LMJ) [1] or National Ignition Facility (NIF) [2] has been the subject of extensive studies. It has been shown that at the wavelength of 351 nm the lifetime of fused silica optics is determined by both surface damage initiation and damage growth [3]. Hence, strategies developed to improve lifetime rely on reducing initiator density and using mitigation techniques to inhibit growth of damage sites induced by residual initiators [4]. As for the nature of damage initiators, it is now well admitted that they can be of two main kinds. A First possible source is subsurface cracks produced during grinding and polishing processes. This subsurface damage (SSD) is embedded under the polishing redeposition layer. Such discontinuities can locally enhance the electric field and be possible initiators [5]. It is possible to decrease laser induced damage density by applying grinding and polishing process variations that minimize SSD [6]. A Second possible source is nano-absorbing centers [7, 8]. If such absorbing centers haven't been detected yet because of a lack of detectivity of existing characterization techniques, laser interaction experiments on gold nano particles embedded in silica have explored the validity of this hypothesis [9, 10].

We herein study the possible relationship existing between polishing induced contamination, as possible absorbing centers, and damage density at the wavelength of 351 nm. Chemo-mechanical description of the polishing process is widely admitted [11, 12]. During polishing, a modified layer, called polishing or Beilby layer is formed. Authors have measured the thickness of this layer to be in the range of approximately 10 to 100 nm [13, 14]. This modified layer is contaminated with polishing agents as seen by means of secondary ion mass spectroscopy (SIMS) [15]. Kozlowski *et al.* tried to correlate the level of polishing induced contaminants with the laser induced damage threshold of fused silica optics polished with different polishing agents (ceria or zirconia). They concluded that the correlation was weak at best [16].

The purpose of the present work is to give a new insight into the effect of polishing induced contaminants upon damage density of polished fused silica parts in the UV. In Section 2 of this paper, we give some information about sample manufacturing. Our raster scan damage testing procedure and its recent developments are described in Section 3. Surface layer analysis (Inductively Coupled Plasma Atomic Emission Spectrometer: ICP-AES) is presented in Section 4. Section 5 is devoted to the analysis and discussions of the obtained results.

2. Sample manufacturing

Seven 100mm diameter, 9mm thick fused silica samples were manufactured by two different vendors using various polishing processes. Samples were cut from Heraeus Suprasil 312 blanks. Parts were polished by two different vendors (A and B) with two different polishing processes. Vendor A used cerium oxide slurry. Vendor B used either cerium oxide or zirconium oxide slurry depending on the sample.

After polishing, some samples were exposed to post processing to modify the amount of polishing induced contaminants in the polishing layer and SSD. For this purpose, two types of post processing were used: acid etching with a 40% HF solution or reactive ion etching (RIE). Post processing was carried out on both sides of the sample with a constant material removal of 2 μ m per side. Sample preparation methods are summarized in Table 1.

Table 1. Sample preparation methods

S/N	Vendor	Slurry type	HF Etching	RIE
A1	A	CeO2	No	No
A2	A	CeO2	No	Yes
A3	A	CeO2	Yes	No
A4	A	CeO2	No	Yes
B1	B	CeO2	No	No
B2	B	ZrO2	No	No
B3	B	ZrO2	No	No

Before damage testing, the samples were cleaned using a soap based cleaning procedure.

3. Damage density measurement : raster scan procedure

Raster scan damage test procedure is usually used to determine the optics damage density as a function of fluence. The goal of this test is to irradiate all the defects which could create damage. Tests are made with small beams. In order to scan the whole area, the optic to be tested is translated continuously along a first direction and stepped along a second direction. The beam overlap, shot to shot, is then a key parameter in order to well irradiate the sample. Repeating this test at several fluences on different areas permits to determine the number of damage sites versus fluence and then the damage density.

The source is a Nd:Yag laser manufactured by Coherent, frequency tripled with the following characteristics: wavelength-355 nm, single longitudinal mode and pulse duration-2.5 ns. During the test, the beam is focused on the sample surface in order to achieve high fluences; beam diameter is then about 400 μ m at 1/e. The depth of focus is about 30 cm, much bigger than usual sample thickness (about 1 to 2 cm). Fluence fluctuations have a standard deviation of about 15% for this laser at 355 nm. When tens of thousands of shots are fired, we can get a total modulation of a factor of 2 in fluence. Thus, it is important to have access to the exact fluence of each shot in order to get a precise correlation between damage occurrence and laser fluence. During procedure, energy, spatial and temporal profiles, position of the beam on the sample are recorded for each shot in order to build up an exact fluence map, corresponding to the scan. A post-mortem observation of irradiated areas, by means of a long working distance microscope, gives an exact damage map. The minimum damage size detected is about 10 μ m whatever the morphology of the damage.

Matching the two maps allows one to extract the shot fluence for each damage site. Data treatment is then realized by gathering damage in several fluence groups. With a fixed fluence, due to fluence fluctuations during the scan, damage density versus fluence is then determined on a large range.

Figure 1 illustrates typical results obtained after complete analysis. Blue points correspond to the treatment described previously. Due to Gaussian beam profile and beam overlap between shots (about 66%), we have to take into account the beam shape to obtain an absolute result. On the graph, one can observe two behaviors. Below 15 J/cm², damage density is roughly constant and damage is not fluence dependent but based only on the defect density; we simply have to take into account the total irradiated area. Above 15 J/cm², damage density increases following a power law. In this domain, damage occurs at the beam maximum fluence and only the Gaussian top part of the profile is taken into account. In this

case, raw data are corrected by a factor that depends on the slope of the fluence law [17, 18]. Ultimately, red points represent the absolute result from the test.

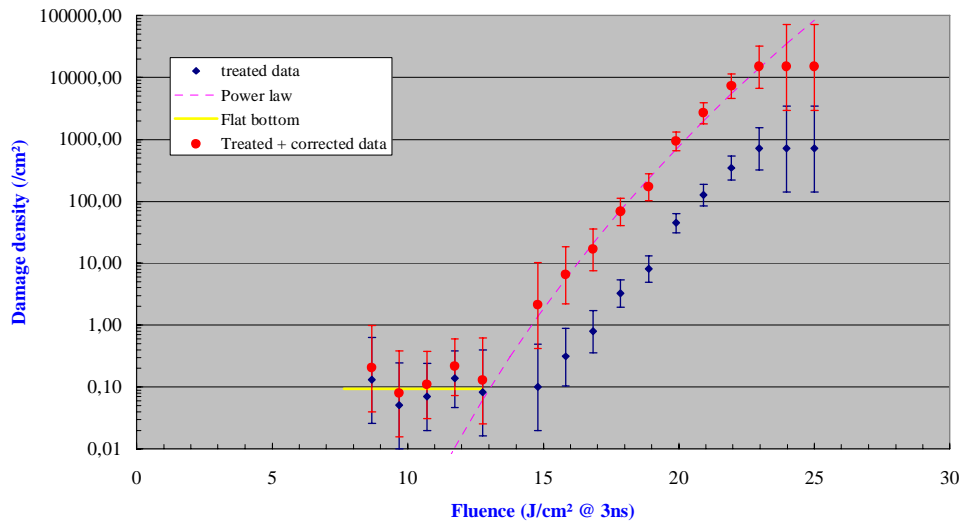


Fig. 1 : Damage density versus fluence. Sample B2. Blue and red points represent respectively treated and “treated + corrected” data. The corrective factors are 1.5 and 21 respectively for the flat bottom and the power law.

4. Redeposition layer contaminants characterization : ICP-AES analyses

The inductively coupled plasma atomic emission spectrometer (ICP-AES) used for the present work was an ACTIVA™ simultaneous solid state detector device (Jobin-Yvon – Horiba, Longjumeau, France). Operating conditions of the instrument are reported in the Table 2. The ICP-AES is equipped with a peristaltic pump for sample uptake. A blank solution is analyzed first, followed by sample solutions and multi-element calibration solutions.

Table 2. ICP-AES instrumental conditions

Spectrometer	ACTIVA™
CCD detector	2048*512 pixels (13.5 μm *13.5 μm)
Frequency/MHz	40.68
Power/W	850 W-1500 W
Outer argon flow/l min ⁻¹	12
Intermediate argon flow/l min ⁻¹	0.15
Aerosol gas flow/l min ⁻¹	1

After accurate weighing and thickness measurement, each fused silica sample was etched (see Fig. 2) during 10 minutes in a mixture of ultra pure grade concentrated HNO₃ and HF (90 % vol/10 % vol). Then the solution was sucked with a 3 mL tube as well as the de-ionized water used for washing. About 0.8 μm of silica was digested during this preparation.

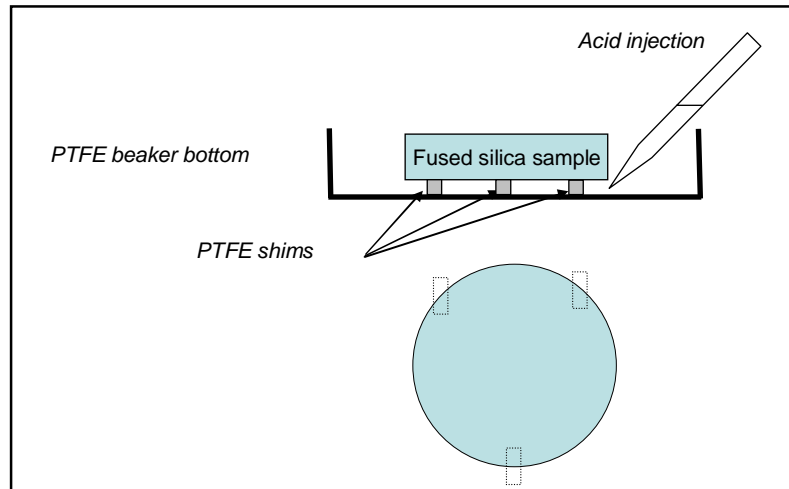


Fig. 2. Sample digestion scheme

This HNO_3/HF cycle was repeated up to 8 times. This was generally enough to obtain asymptotic impurities concentrations. After this controlled sample digestion, suitable spectra can be obtained for the main impurities (Ce, La, Zr, Hf, Al, Fe, Cu). The wavelengths used for ICP measurements are summarized in Table 3.

Table 3. wavelengths for impurities ICP measurements

Element	Wavelength (nm)
Ce	395.254, 413.380, 413.765
La	408.671
Zr	339.198, 343.823, 343.621
Hf	264.141, 282.022
Al	167.020, 396.152
Fe	259.940, 238.204
Cu	244.700, 324.754

5. Results and discussions

The seven manufactured samples were tested using the damage testing procedure detailed in Section 3. They mainly damaged on the exit face. The damaged side of each sample is then characterized owing to the method described in section 4. Elements introduced by the grinding or polishing processes and leading to strong absorption in the UV are monitored: Ce, Al, Cu, Fe, Zr, La. Each of them is tracked in the depth of the interface until signal goes to an asymptote consistent with bulk fused silica impurity content itself.

This analytical procedure allows us to evaluate concentrations of impurities as a function of depth. Figure 3 illustrates the surface and sub-surface depth profiles of impurities that can be obtained with this analytical procedure and gives by the way an average value for maximum depth of sub-surface cracks. Results are given with a relative precision of 10%.

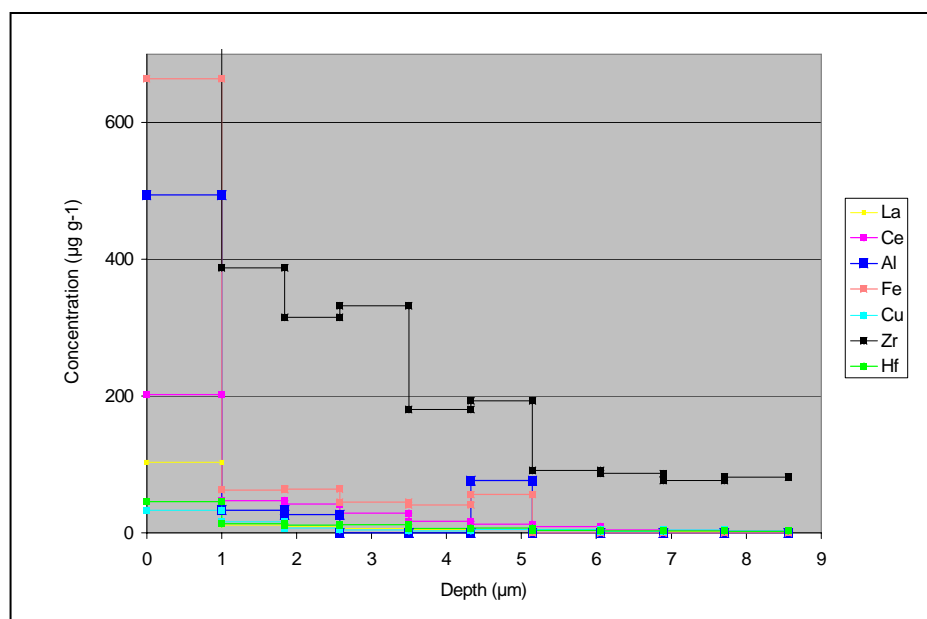


Fig. 3. Depth profiles of impurities concentrations for sample B2

Because of its global surface digestion capabilities, such a procedure is of great interest compared to local ($100 \times 100 \mu\text{m}^2$) SIMS analyses. However the analyzable surface can be reduced and localized to particular zones if necessary.

Table 4 gives the results of the damage and impurities measurement of the seven samples. In order to ease the analysis, we only study the damage density at a fixed fluence of 14 J/cm^2 , 3ns pulse length. Regarding impurities, the cumulated amount of each contaminant in the interface is calculated expressed in nanograms. This quantity is then divided by the maximal depth where contamination is assumed to disappear, expressed in microns. For all the considered samples, this maximal depth is in the range of 5 to $10 \mu\text{m}$.

Table 4. Sample characterization: damage density and impurity concentration for each element in $\text{ng}/\mu\text{m}$

S/N	Damage density per cm^2 at 14 J/cm^2 , 3ns	Al	Cu	Ce	Zr	Hf	La	Fe
A1	7,22	2204	518	4529	-	-	1741	5548
A2	5,4	739	200	3491	-	-	1136	1582
A3	1	1950	745	471	-	-	114	2770
A4	4,7	1611	362	3764	-	-	1150	3915
B1	17	1963	384	10733	-	-	6974	1838
B2	0,1	1113	149	647	5498	192	269	1642
B3	0,6	1339	53	378	24464	368	142	2295

Note that cerium contamination is always associated with lanthanum since cerium slurries are most of the time a mix of both these elements. The same comment can be made with zirconium and hafnium. Dealing with zirconium polished parts B2 and B3, we can notice a small quantity of cerium existing in the polished part interface. The zirconium slurry used has been measured by ICP and is free of cerium. We believe that this cerium has been introduced by some polishing done with cerium slurry of another part on the polishing

machine before the manufacturing of our part. Insufficient cleaning of the polishing machine before the ZrO₂ polishing of samples B2 and B3 is therefore likely to be the cause of the cerium pollution of these parts. Moreover, it must be noticed that a high concentration of zirconium is compatible with low damage density such as seen on part B3. This last remark has already been made [16]. Figure 4 shows the correlation existing between cerium content in the interface and damage density at 14 J/cm².

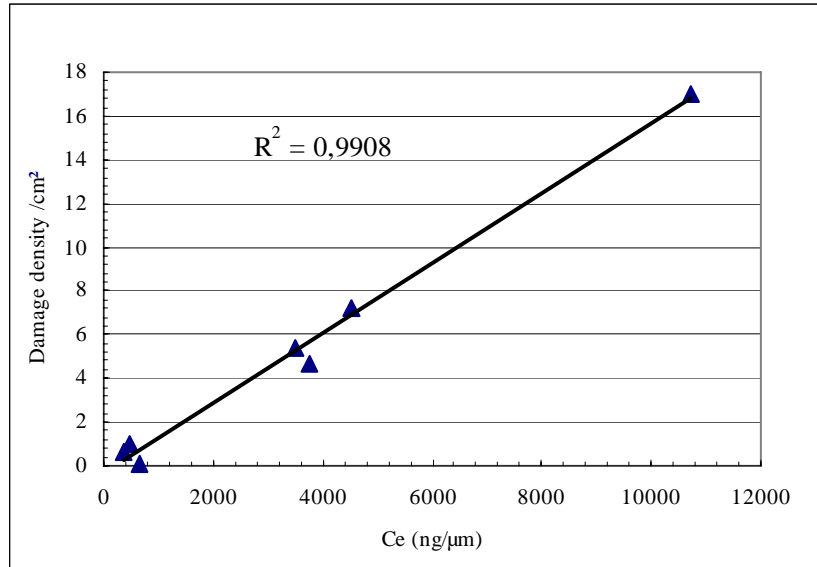


Fig. 4. Effect of cerium content on damage density.

Data are fitted with a linear law with a correlation coefficient of 0.99 approximately. At the opposite, Figure 5 presents the data for Fe where correlation between damage density and Fe concentration is very weak.

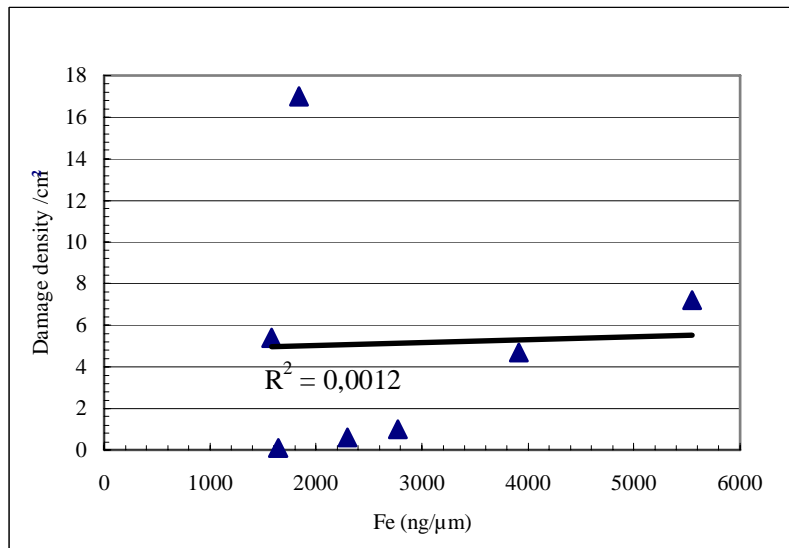


Fig. 5. Effect of Fe content on damage density.

Table 5 details the correlation coefficients calculated for each element.

Table 5. Influence of each element on damage density

Element	R ²
Ce	0,99
La	0,94
Al	0,16
Cu	0,03
Fe	0,001

Al, Cu and Fe contents have a very weak influence on damage density. On the contrary, cerium and lanthanum contents of the interface are closely related to the damage density at 14 J/cm². Since cerium absorption coefficient in the UV is strong [16], we believe this element is involved in the damage of our samples. We can also notice that for low cerium concentration samples (A3, B2 and B3) this correlation is weaker since damage density is varying up to a decade while cerium vary of a factor of 2. It could mean that the role of cerium is less prevalent for samples with damage density of less than one damage per cm². More extensive studies of low damage density samples would be needed to give a clear insight of this phenomenon.

We have also been trying to correlate the presence of cerium in the interface with damage morphology. On part B1 exhibiting very high cerium concentration in the interface, the "gray haze" damage morphology can be easily seen such as previously described by Kozłowski *et al.* [16]. Figure 6(a) shows such a gray haze damage like observed with a Nomarski microscope. When cerium content decreases, the gray haze morphology disappears to leave place to more classical small damage sites such as depicted in Figure 6(b). Some small damage clusters can be observed but no clear correlation has been seen between cerium concentration and quantities of these clusters like damage sites.

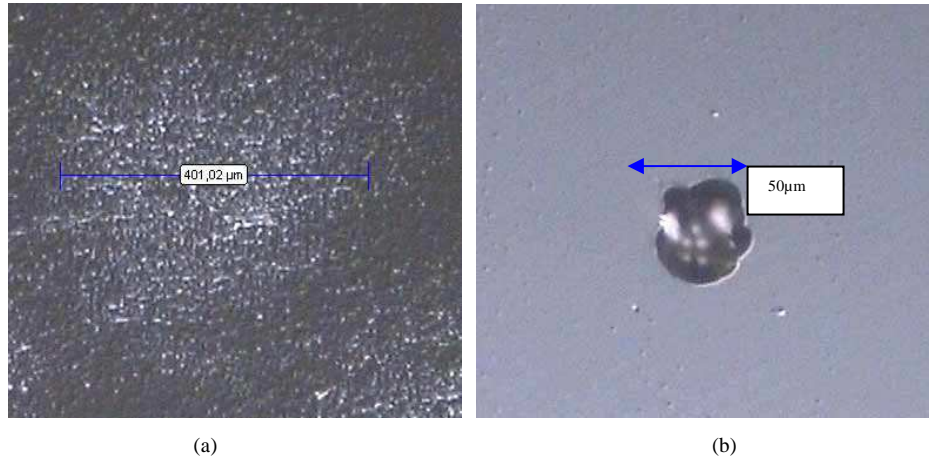


Fig. 6. (a) Gray haze damage, part B1 (b) typical damage morphology on part A4

6. Conclusion

We have demonstrated that for polished fused silica parts having a damage density in the range of 1 to 100 damage per centimeter square at 14 J/cm², 3ns, cerium contamination induced by the polishing process is likely to be involved in the damage mechanism. This has been shown using two types of polishing processes in combination with various post

processing steps. In terms of damage morphology, no specific morphology could be associated with this cerium pollution at low damage density.

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